

**Features:**

- Isolated mounting base 2500V~
  - Pressure contact technology with Increased power cycling capability
  - Space and weight saving
- Typical Applications**
- Various rectifiers
  - DC supply for PWM inverter

<b>V<sub>RRM</sub></b>	Type & Outline		
	<b>800V</b>	<b>1000V</b>	<b>1200V</b>
<b>1400V</b>	MDC240-14-216F3A		
<b>1600V</b>	MDC240-16-216F3A		
<b>1800V</b>	MDC240-18-216F3A		
<b>1800V</b>	MD240-18-216F3AG		

<b>SYMBOL</b>	<b>CHARACTERISTIC</b>	<b>TEST CONDITIONS</b>	<b>T<sub>j</sub>(°C)</b>	<b>VALUE</b>			<b>UNIT</b>
				<b>Min</b>	<b>Type</b>	<b>Max</b>	
I <sub>F(AV)</sub>	Mean forward current	180° half sine wave 50Hz Single side cooled, T <sub>c</sub> =100°C	150			240	A
I <sub>F(RMS)</sub>	RMS forward current					378	A
I <sub>RRM</sub>	Repetitive peak current	at V <sub>RRM</sub>	150			20	mA
I <sub>FSM</sub>	Surge forward current	V <sub>R</sub> =60%V <sub>RRM</sub> , t=10ms half sine,	150			7.5	kA
I <sup>2</sup> t	I <sup>2</sup> t for fusing coordination					281	10 <sup>3</sup> A <sup>2</sup> s
V <sub>FO</sub>	Threshold voltage		150			0.75	V
r <sub>F</sub>	Forward slope resistance					0.70	mΩ
V <sub>FM</sub>	Peak forward voltage	I <sub>FM</sub> =720A	25			1.60	V
R <sub>th(j-c)</sub>	Thermal resistance Junction to case	At 180° sine. Single side cooled per chip				0.18	°C/W
R <sub>th(c-h)</sub>	Thermal resistance case to heatsink	At 180° sine. Single side cooled per chip				0.08	°C/W
V <sub>iso</sub>	Isolation voltage	50Hz,R.M.S,t=1min,I <sub>iso</sub> :1mA(MAX)		2500			V
<b>F<sub>m</sub></b>	Terminal connection torque(M6)			4.5		6.0	N·m
	Mounting torque(M6)			4.5		6.0	N·m
T <sub>vj</sub>	Junction temperature			-40		150	°C
T <sub>stg</sub>	Stored temperature			-40		125	°C
W <sub>t</sub>	Weight				330		g
<b>Outline</b>				216F3A			

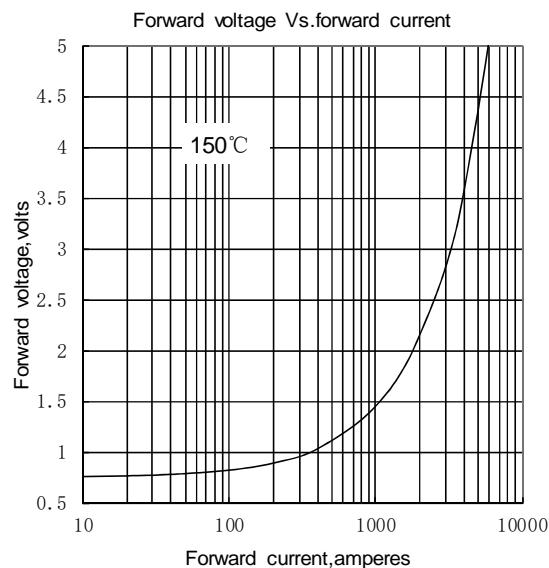


Fig.1

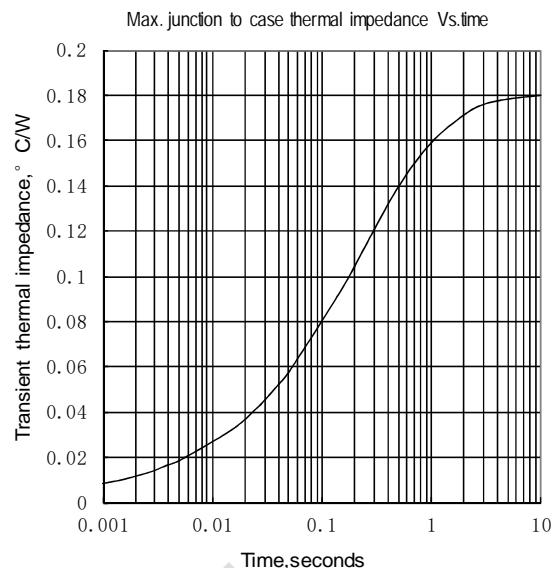


Fig.2

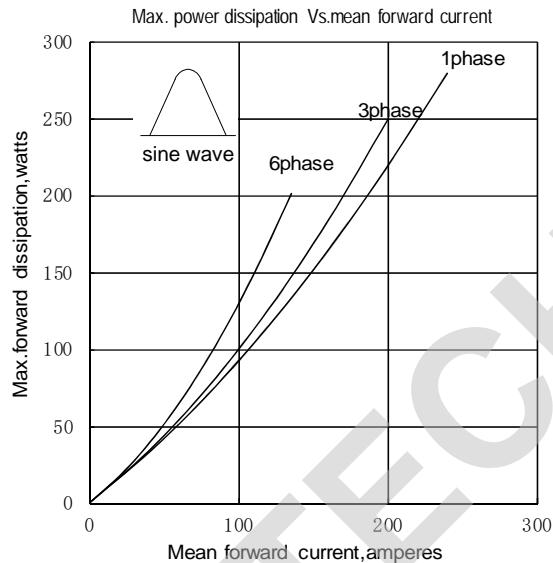


Fig.3

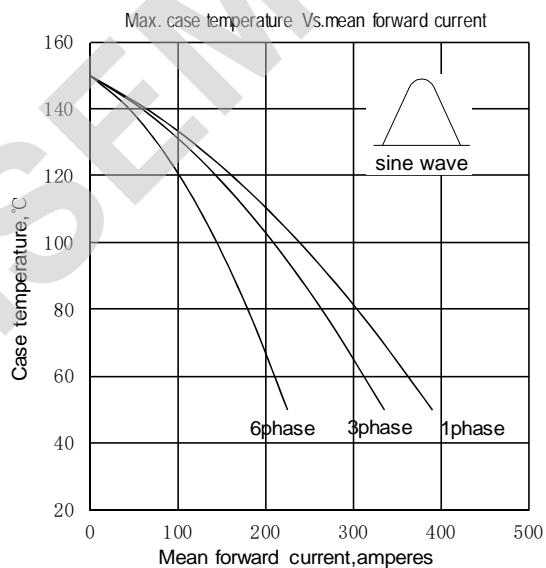


Fig.4

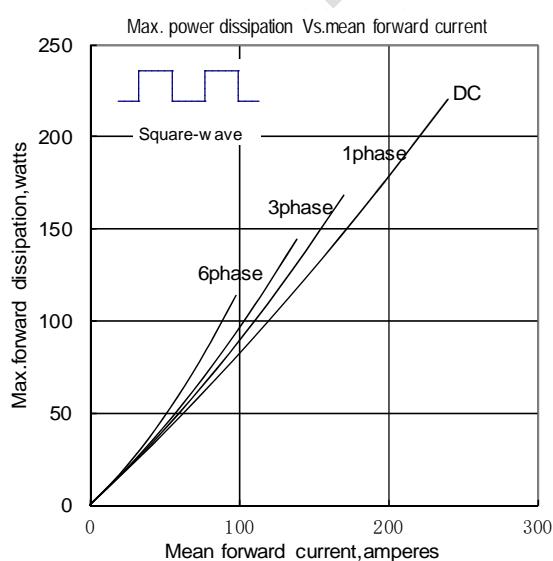


Fig.5

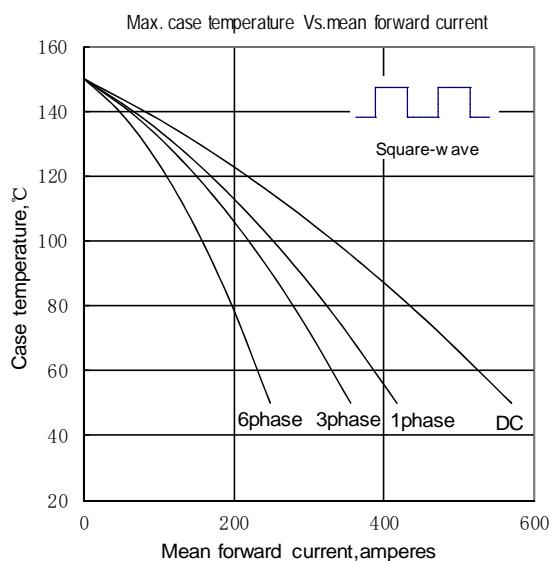


Fig.6

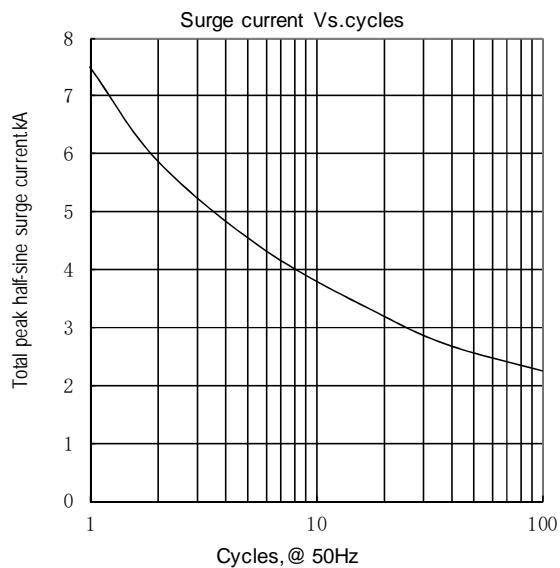


Fig.7

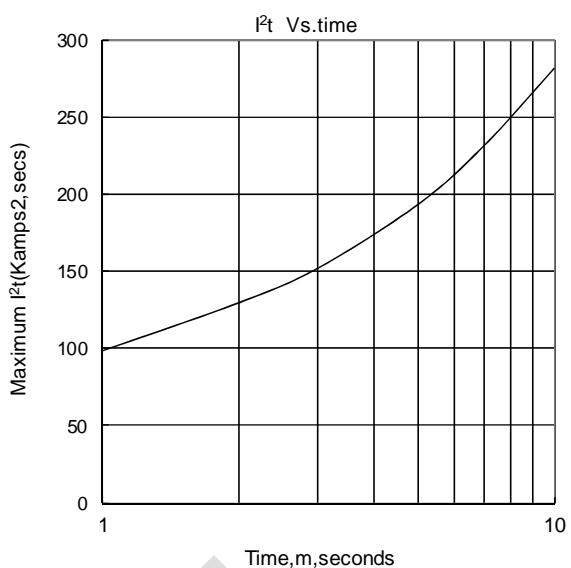


Fig.8

**Outline:**